

IEC60730BSERN

IEC60730B Example release notes

Rev. 1 — 07/2021

Release Notes

by: NXP Semiconductors

1 Introduction

These release notes describe important release information for the IEC60730B safety example application released with IEC60730B library v4.1.

All information about IEC60730B are at www.nxp.com/iec60730.

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2 What is new

The example released with the IEC60730B library version v4_1 contains example projects for the following boards:

Table 1. Device with available example projects

| Development board | Version of library | Example projects available in MCUXpresso SDK |
|-------------------|--------------------|--|
| evkmimxrt1060 | 4.1 | SDK 2.10 |
| evkbmimxrt1060 | 4.1 | SDK 2.10 |
| frdmk22f | 4.1 | SDK 2.10 |
| lpcxpresso51u68 | 4.1 | SDK 2.10 |
| evkmimxrt1170 | 4.1 | SDK 2.10 |
| lpcxpresso845max | 4.1 | SDK 2.9 |
| lpcxpresso824max | 4.1 | SDK 2.9 |
| frdmkv11z | 4.1 | SDK 2.9 |
| frdmke15z | 4.1 | SDK 2.9 |
| frdmk32l2a4s | 4.1 | SDK 2.9 |
| evkmimx8mm | 4.1 | SDK 2.9 |
| evkmimxrt1020 | 4.1 | SDK 2.9 |
| evkmimxrt1024 | 4.1 | SDK 2.9 |
| evkbimxrt1050 | 4.1 | SDK 2.9 |
| frdmkv31f | 4.1 | SDK 2.9 |
| lpcxpresso55s69 | 4.1 | SDK 2.9 |
| lpcxpresso55s28 | 4.1 | SDK 2.9 |
| evkmimx8mn | 4.1 | SDK 2.9 |

Table continues on the next page...



Table 1. Device with available example projects (continued)

| Development board | Version of library | Example projects available in MCUXpresso SDK |
|-------------------|--------------------|--|
| frdmkl26z | 4.1 | For example please contact an NXP representative |
| frdmke02z40m | 4.1 | For example please contact an NXP representative |
| twrke18f | 4.1 | For example please contact an NXP representative |
| twrkv58f220m | 4.1 | For example please contact an NXP representative |
| twrkv46f150m | 4.1 | For example please contact an NXP representative |
| frdmk32l2b3 | 4.1 | For example please contact an NXP representative |

Updates in version 4.1.

- **WDOG test function consolidated** - the function for the specific timer was merged to one with parameters that select the correct refresh sequence for a dedicated WDOG.
- **Hardware flash test on i.MXRT10xx** - The hardware test is now supported also for i.MXRT1010 and other devices with the same DCP module.
- **Analog I/O test on i.MXRT10xx** - software triggered version of the Analog I/O test was added.
- **Newly supported devices** - frdmk32l2b3, frdmk32l2a4s, lpcxpresso55s28, evkmimx8mn, evkmimx8mm, evkmimxrt1024, evkmimxrt1170, frdmk22f.
- **Updated device** - The examples for Kinetis devices were updated from version 3 to example version 4.1.
- **frdm-ke15z** - The ADC test is now set for a 5 V reference. This is set in the *safety_config.h* file. For more information, see the corresponding example user's guide.

3 Development tools

The safety IEC60730B example application were tested with the following development tools:

- IAR Embedded Workbench IDE version 9.10.2
- Arm[®]-MDK - Keil[®] µVision[®] version 5.34
- MCUXpresso IDE version 11.4.0

[FreeMASTER tool version 3.0](#) was used for application monitoring.

4 Known issues or important changes

This chapter contains the description of known issues or non-standard behavior of the released example.

MIMX8M Mini and Nano

The MIMX8M Mini and Nano application examples are not provided for the Keil and MCUXpresso IDEs.

LPCxpresso80x - MCUXpresso IDE

The FreeMASTER monitoring is turned off due to small memory size of the MCU.

FRDM-KL26 uVision Keil support

The current version of the SDK does not support KL26 with the ArmV6 compiler.

FRDM-KW36/38 uVision Keil support

Example for KW36/38 in uVision Keil not supported.

FRDM-KE02z uVision support

The MKE02Z application example is not provided for the Keil IDE.

TWR-KV58F220M - uVision support

In the uVision Keil, turn off the flash test due to a problem with the download of the edited binary file by the debugger.

5 Revision history

Table 2. Revision table

| Revision | SDK | Description |
|----------|--------|--|
| Rev 0 | 2.9.0 | Initial release |
| Rev 1 | 2.10.0 | Change devices supported in SDK rel. 2.10. |

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